

Technical Data Sheet

Product Description

CR Technology offers a wide variety of thermally conductive pads also known as gap fillers. These materials are available in both silicone and non-silicone formulations. EVERTHERM pads offer an endless range of thermal conductivity, softness and thickness options to easily solve any heat related issue. EVERTHERM pads are naturally tacky and can be cut to any size or shape for easy installation. EVERTHERM pads are designed and engineered to achieve the highest level of thermal management to protect today's most advanced electronics.



Sheet Size: 300mm x 400mm

Material Properties

- High thermal conductivity
- Excellent flame retardant
- Good electrical insulation performance
- Good flexibility and high compression ratio

EVSF 800

Color	Gray	visual
Thickness	0.5 - 3.0mm	ASTM D374
Specific Gravity	3.40g/cc	ASTM D792
Thermal Conductivity	8.0 W/m-K	ASTM D5470
Hardness (Shore OO)	50	ASTM D2240
Elongation	15%	ASTM D412
Tensile Strength	10psi	ASTM D412
Breakdown Voltage AC(KV)	>2@0.5MM >4@0.75MM	ASTM D149
UL Flammability Rating	UL94 V-0	E355606
Volume resistivity	1*10 ¹³ Ω.cm	ASTM D257
Operating Temperature	-50~ 200°C	---
Thermal Resistance(1mm,@40psi)	0.29°C*in ² /W	ASTM D5470
Compression Ratio(1mm,@40psi)	15%	---
Dielectric Constant 1MHz	5.5	ASTM D150
RoHS (10)	PASS	IEC 62321
Halogen (4)	PASS	EN14582
REACH (191)	PASS	EN14372

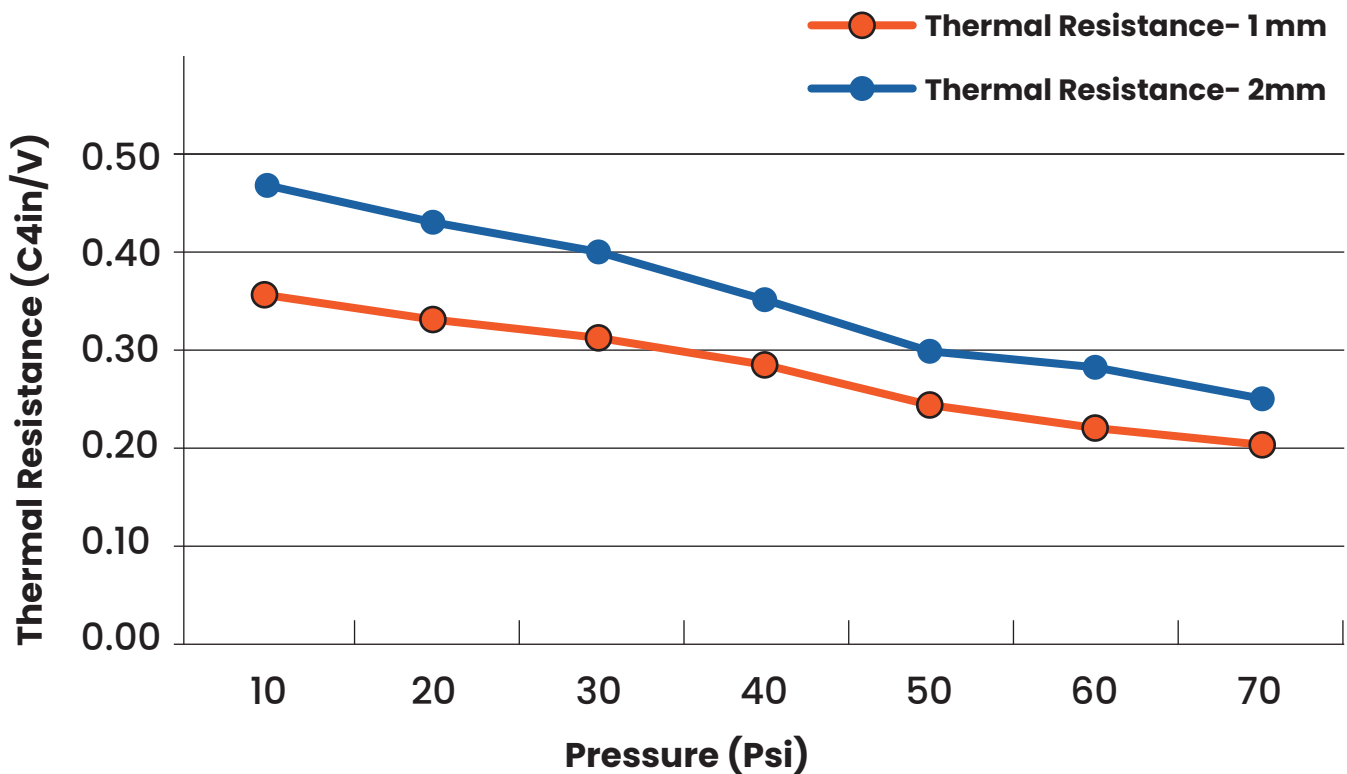
Test fixtures using ASTM D5470. Recorded values include interface thermal resistance. These values are for reference only. The actual application performance is directly related to the applied surface roughness, flatness and pressure.

Applications

- ✓ Semiconductor heat sink
- ✓ Electric Vehicle (EV) Batteries
- ✓ Communication & power devices & modules
- ✓ LED lighting equipment
- ✓ Electronic components like:
LEDs, CPUs, MOS • Mobiles, Laptops, Tablets

EVSF 600G

Thermal Resistance VS Pressure



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Note: The information provided herein is accurate at time of publication. It is the responsibility of the end-user to confirm compliance to their application. All test data is typical. Therefore, these recommendations and data are for reference only and not as a product warranty.